

## **HAT2173H**

# Silicon N Channel Power MOS FET Power Switching

REJ03G0030-0200 Rev.2.00 Sep 26, 2005

#### **Features**

- High speed switching
- Capable of 8 V gate drive
- Low drive current
- High density mounting
- Low on-resistance  $R_{DS(on)} = 12 \ m\Omega \ typ. \ (at \ V_{GS} = 10 \ V)$

#### **Outline**

RENESAS Package code: PTZZ0005DA-A)
(Package name: LFPAK )

5
D
4
G
1, 2, 3 Source
4 Gate
5 Drain

## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	100	V
Gate to source voltage	$V_{GSS}$	±20	V
Drain current	I <sub>D</sub>	25	А
Drain peak current	I <sub>D(pulse)</sub> Note1	100	А
Body-drain diode reverse drain current	I <sub>DR</sub>	25	А
Avalanche current	I <sub>AP</sub> Note 2	25	А
Avalanche energy	E <sub>AR</sub> Note 2	62.5	mJ
Channel dissipation	Pch Note3	30	W
Channel to Case Thermal Resistance	θch-C	4.17	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

- 2. Value at Tch = 25°C, Rg  $\geq$  50  $\Omega$
- 3.  $Tc = 25^{\circ}C$

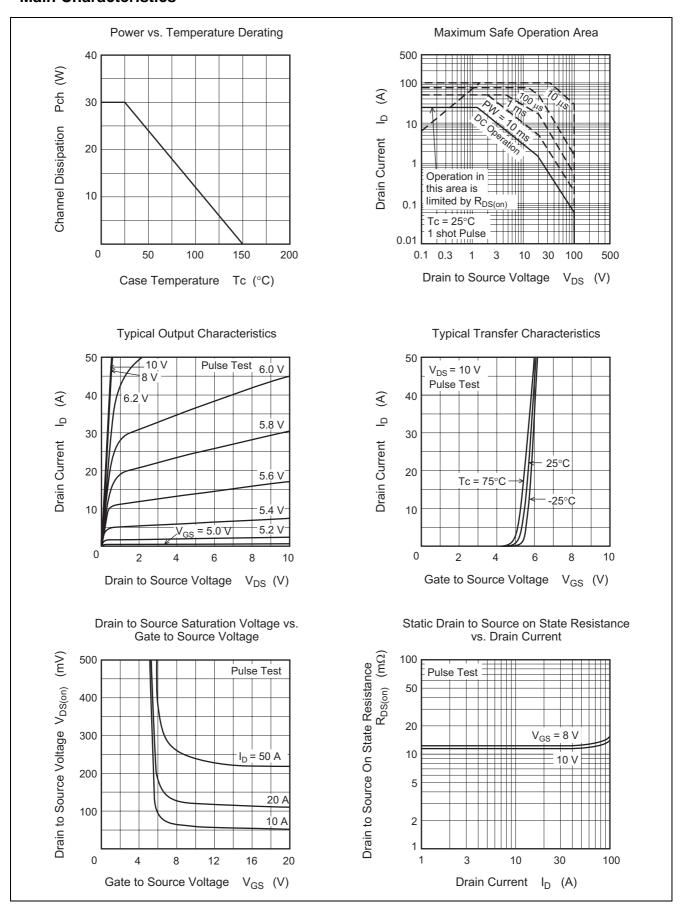
## **Electrical Characteristics**

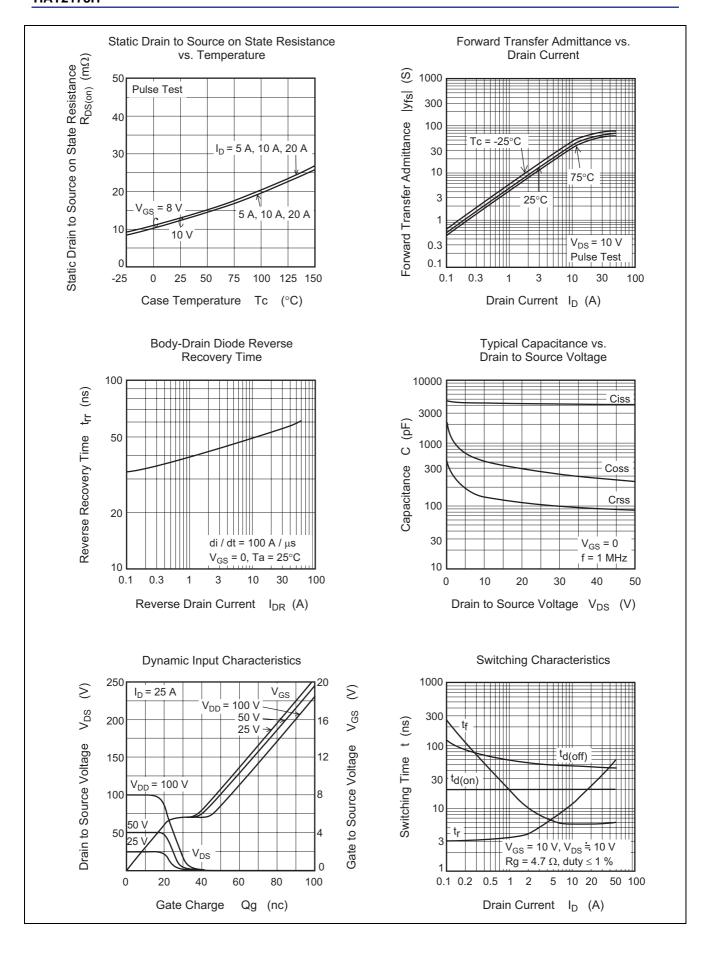
 $(Ta = 25^{\circ}C)$ 

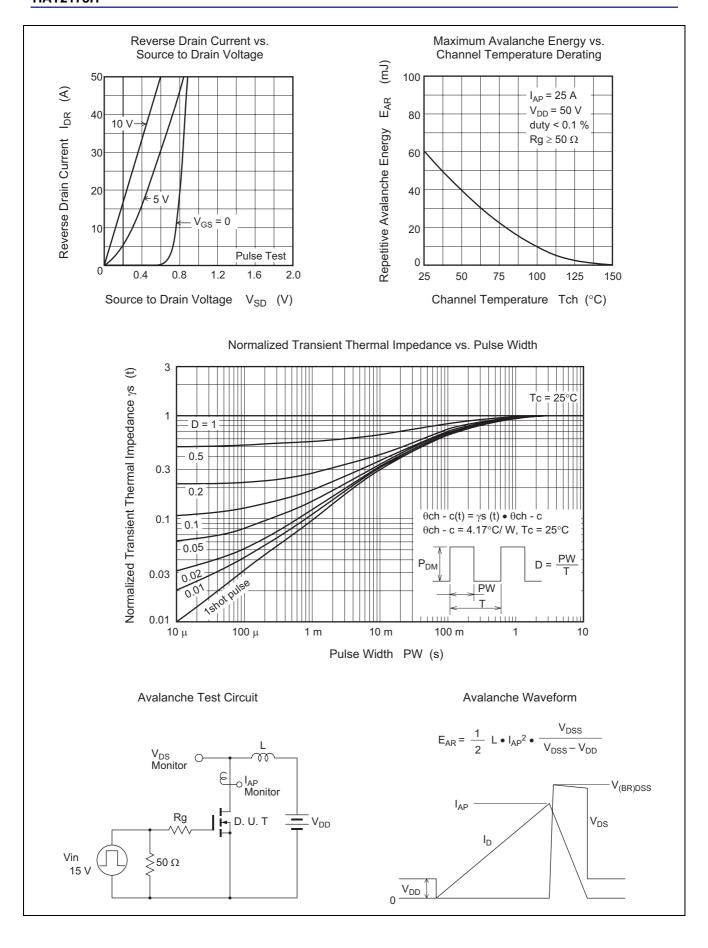
Item	Symbol	Min	Тур	Max	Unit	Test Conditions	
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	100	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$	
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$	
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 100 \text{ V}, V_{GS} = 0$	
Gate to source cutoff voltage	$V_{GS(off)}$	4.0	_	6.0	V	$V_{DS} = 10 \text{ V}, I_D = 20 \text{ mA}$	
Static drain to source on state	R <sub>DS(on)</sub>	_	12	15	mΩ	$I_D = 12.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$	
resistance	R <sub>DS(on)</sub>	_	13	17.5	mΩ	$I_D = 12.5 \text{ A}, V_{GS} = 8 \text{ V}^{\text{Note4}}$	
Forward transfer admittance	y <sub>fs</sub>	27	45		S	$I_D = 12.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$	
Input capacitance	Ciss	_	4350		pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$	
Output capacitance	Coss	_	520		pF	f = 1 MHz	
Reverse transfer capacitance	Crss	_	150	_	pF		
Gate resistance	Rg	_	0.5	_	Ω		
Total gate charge	Qg	_	61	_	nC	$V_{DD} = 50 \text{ V}, V_{GS} = 10 \text{ V},$	
Gate to source charge	Qgs	_	23	_	nC	I <sub>D</sub> = 25 A	
Gate to drain charge	Qgd	_	14.5	_	nC		
Turn-on delay time	t <sub>d(on)</sub>	_	20	_	ns	$V_{GS} = 10 \text{ V}, I_D = 12.5 \text{ A},$ $V_{DD} \cong 30 \text{ V}, R_L = 2.4 \Omega,$	
Rise time	t <sub>r</sub>	_	15	_	ns		
Turn-off delay time	t <sub>d(off)</sub>	_	37	_	ns	$Rg = 4.7 \Omega$	
Fall time	t <sub>f</sub>	_	5.7	_	ns		
Body-drain diode forward voltage	$V_{DF}$	_	0.82	1.07	V	$IF = 25 A$ , $V_{GS} = 0$ Note4	
Body-drain diode reverse recovery	t <sub>rr</sub>	_	55	_	ns	$IF = 25 A, V_{GS} = 0,$	
time						di <sub>F</sub> / dt = 100 A/ μs	

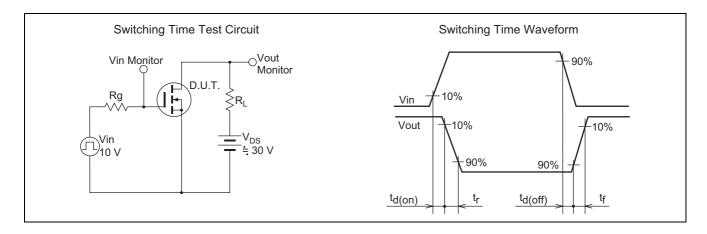
Notes: 4. Pulse test

#### **Main Characteristics**

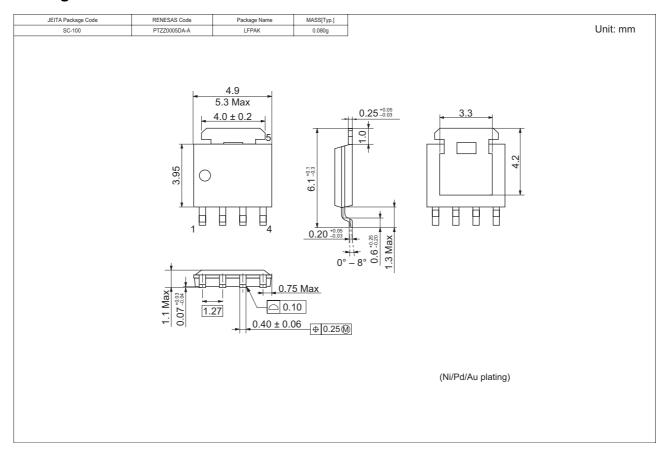








## **Package Dimensions**



## **Ordering Information**

Part Name	Quantity	Shipping Container
HAT2173H-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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